

# Single 5V AppleTalk® Transceiver

January 1994

## FEATURES

- Single Chip Provides Complete LocalTalk®/AppleTalk Port
- Operates From a Single 5V Supply
- ESD Protection to 10kV on Receiver Inputs and Driver Outputs
- Low Power:  $I_{CC} = 2.4\text{mA Typ}$
- Shutdown Pin Reduces  $I_{CC}$  to  $0.5\mu\text{A Typ}$
- Receiver Keep-Alive Function:  $I_{CC} = 65\mu\text{A Typ}$
- Differential Driver Drives Either Differential AppleTalk or Single-Ended EIA562 Loads
- Drivers Maintain High Impedance in Three-State or with Power Off
- Thermal Shutdown Protection
- Drivers are Short-Circuit Protected

## APPLICATIONS

- LocalTalk Peripherals
- Notebook/Palmtop Computers
- Battery-Powered Systems

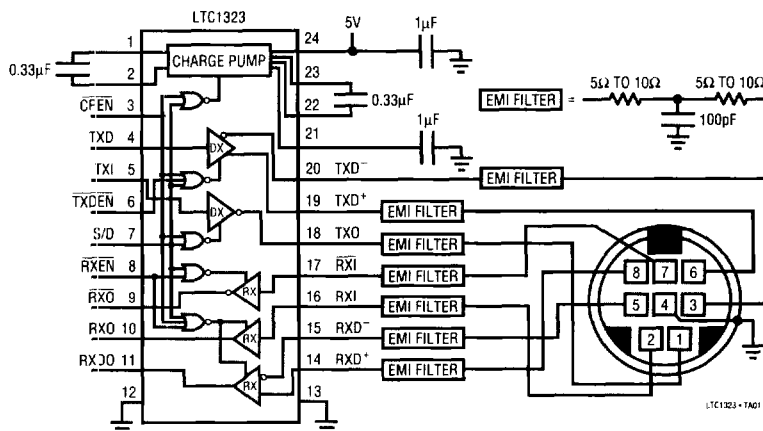
## DESCRIPTION

The LTC1323 is a single 5V line transceiver designed to operate on Appletalk or EIA562 networks. The LTC1323 is available in 16-pin or 24-pin versions, each includes a differential RS422 compatible transceiver. A charge pump generates the chip's  $-5\text{V}$  supply which may also be used to power an external device. The 24-pin LTC1323 includes an additional dedicated EIA562 driver and two EIA562 receivers, one of which features a micropower keep-alive mode which can be used for monitoring external wake-up signals. The LTC1323 draws only  $2.4\text{mA}$  quiescent current when active,  $65\mu\text{A}$  in receiver keep-alive mode, and  $0.5\mu\text{A}$  in shutdown making it ideal for use in battery-powered systems.

The differential driver will drive either differential AppleTalk loads or EIA562 single-ended loads. The driver outputs three-state when disabled, during shutdown, in receiver keep-alive mode, or when the power is off. The driver outputs will maintain high impedance even with output common-mode voltages beyond the power supply rails. Both the driver outputs and receiver inputs are protected against ESD damage to  $10\text{kV}$ .

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## TYPICAL APPLICATION



## ABSOLUTE MAXIMUM RATINGS

Supply Voltage ( $V_{CC}$ ) ..... 7V  
 Input Voltage  
     Logic Inputs .....  $-0.3V$  to  $V_{CC} + 0.3V$   
     Receiver Inputs .....  $\pm 15V$   
 Driver Output Voltage (Forced) .....  $\pm 15V$

Driver Short-Circuit Duration ..... Indefinite  
 Operating Temperature Range .....  $0^{\circ}C$  to  $70^{\circ}C$   
 Storage Temperature Range .....  $-65^{\circ}C$  to  $150^{\circ}C$   
 Lead Temperature (Soldering, 10 sec) .....  $300^{\circ}C$

## PACKAGE/ORDER INFORMATION

<p>S PACKAGE 16-LEAD PLASTIC SOL <math>T_{JMAX} = 125^{\circ}C, \theta_{JA} = 85^{\circ}C/W</math></p>	ORDER PART NUMBER	<p>S PACKAGE 24-LEAD PLASTIC SOL <math>T_{JMAX} = 125^{\circ}C, \theta_{JA} = 85^{\circ}C/W</math></p>	ORDER PART NUMBER
	LTC1323CS-16		LTC1323CS

Consult factory for Industrial and Military grade parts

## ELECTRICAL CHARACTERISTICS $V_{CC} = 5V \pm 10\%, T_A = 0^{\circ}C$ to $70^{\circ}C$ (Notes 2, 3)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
<b>Supplies</b>							
$I_{CC}$	Normal Operation Supply Current	No Load, $SD = 0V, \overline{CPEN} = 0V, \overline{TXDEN} = 0V, \overline{RXEN} = 0V$	●	2.4	4	mA	
	Receiver Keep-Alive Supply Current	No Load, $SD = 0V, \overline{CPEN} = V_{CC}, \overline{TXDEN} = 0V, \overline{RXEN} = 0V$	●	65	100	$\mu A$	
	Shutdown Supply Current	No Load, $SD = V_{CC}, \overline{CPEN} = X, \overline{TXDEN} = X, \overline{RXEN} = 0V$	●	0.5	10	$\mu A$	
$V_{EE}$	Negative Supply Output Voltage	$I_{LOAD} \leq 10mA$ (Note 4), $V_{CC} = 5V, R_L = 100\Omega$ (Figure 1), $TXI = V_{CC}, R_{TXO} = 3k$ (Figure 5)	●	-5.5	-5	-4.5	V
$f_{OSC}$	Charge Pump Oscillator Frequency			200		kHz	
<b>Differential Driver</b>							
$V_{OD}$	Differential Output Voltage	No Load $R_L = 100\Omega$ (Figure 1)	●	$\pm 8$		V	
$\Delta V_{OD}$	Change in Magnitude of Differential Output Voltage	$R_L = 100\Omega$ (Figure 1)	●		0.2	V	

## ELECTRICAL CHARACTERISTICS $V_{CC} = 5V \pm 10\%$ , $T_A = 0^\circ C$ to $70^\circ C$ (Notes 2, 3)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
<b>Differential Driver</b>							
$V_{OC}$	Differential Common-Mode Output Voltage	$R_L = 100\Omega$		3		V	
$V_{OS}$	Single-Ended Output Voltage	No Load $R_L = 3k$ to GND	● $\pm 4.5$ ● $\pm 3.7$			V V	
$V_{CMR}$	Common-Mode Range	$SD = V_{CC}$ or $\overline{CPEN} = V_{CC}$ or Power Off	●		$\pm 10$	V	
$I_{SS}$	Short-Circuit Current	$-5V \leq V_O \leq 5V$	●	35	120	250	mA
$I_{OZ}$	Three-State Output Current	$SD = V_{CC}$ or $\overline{CPEN} = V_{CC}$ or Power Off, $-10V \leq V_O \leq 10V$	●		$\pm 2$	$\pm 200$	$\mu A$
<b>Single-Ended Driver (Note 5)</b>							
$V_{OS}$	Single-Ended Output Voltage	No Load $R_L = 3k$ to GND	● $\pm 4.5$ ● $\pm 3.7$			V V	
$V_{CMR}$	Common-Mode Range	$SD = V_{CC}$ or $\overline{CPEN} = V_{CC}$ or $\overline{TXDEN} = V_{CC}$ or Power Off	●		$\pm 10$	V	
$I_{SS}$	Short-Circuit Current	$-5V \leq V_O \leq 5V$	●	35	220	500	mA
$I_{OZ}$	Three-State Output Current	$SD = V_{CC}$ or $\overline{CPEN} = V_{CC}$ or $\overline{TXDEN} = V_{CC}$ or Power Off, $-10V \leq V_O \leq 10V$	●		$\pm 2$	$\pm 200$	$\mu A$
<b>Receivers</b>							
$R_{IN}$	Input Resistance	$-7V \leq V_{IN} \leq 7V$	●	12		k $\Omega$	
	Differential Receiver Threshold Voltage	$-7V \leq V_{CM} \leq 7V$	●	-200	200	mV	
	Differential Receiver Input Hysteresis	$-7V \leq V_{CM} \leq 7V$	●	70		mV	
	Single-Ended Input, Low Voltage	(Note 5)	●		0.8	V	
	Single-Ended Input, High Voltage	(Note 5)	●	2		V	
$V_{OH}$	Output High Voltage	$I_O = -4mA$	●	3.5		V	
$V_{OL}$	Output Low Voltage	$I_O = 4mA$	●		0.4	V	
$I_{SS}$	Output Short-Circuit Current	$-5V \leq V_O \leq 5V$	●	7	85	mA	
$I_{OZ}$	Output Three-State Current	$-5V \leq V_O \leq 5V$ , $\overline{RXEN} = V_{CC}$	●		$\pm 2$	$\pm 100$	$\mu A$
<b>Logic Inputs</b>							
$V_{IH}$	Input High Voltage	All Logic Input Pins	●	2.0		V	
$V_{IL}$	Input Low Voltage	All Logic Input Pins	●		0.8	V	
$I_C$	Input Current	All Logic Input Pins	●		$\pm 1.0$	$\pm 20$	$\mu A$
<b>Switching Characteristics</b>							
$t_{PLH}$ , $t_{PHL}$	Differential Driver Propagation Delay	$R_L = 100\Omega$ , $C_L = 100pF$ (Figures 2, 7)	●	40	120	ns	
	Differential Driver Propagation Delay with Single-Ended Load	$R_L = 3k$ , $C_L = 100pF$ (Figures 3, 9)	●	120	180	ns	
	Single-Ended Driver Propagation Delay	$R_L = 3k$ , $C_L = 100pF$ , (Figures 5, 10) (Note 5)	●	40	120	ns	
	Differential Receiver Propagation Delay	$C_L = 15pF$ (Figures 2, 11)	●	70	160	ns	
	Single-Ended Receiver Propagation Delay	$C_L = 15pF$ (Figures 6, 12) (Note 5)	●	70	160	ns	
	Inverting Receiver Propagation Delay in Keep-Alive Mode, $SD = 0V$ , $\overline{CPEN} = V_{CC}$	$C_L = 15pF$ (Figures 6, 12) (Note 5)	●	150	400	ns	
$t_{SKEW}$	Differential Driver Output to Output	$R_L = 100\Omega$ , $C_L = 100pF$ (Figures 2, 7)	●	10	50	ns	

## ELECTRICAL CHARACTERISTICS $V_{CC} = 5V \pm 10\%$ , $T_A = 0^\circ C$ to $70^\circ C$ (Notes 2 and 3)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
<b>Switching Characteristics</b>						
$t_r, t_f$	Differential Driver Rise/Fall Time	$R_L = 100\Omega, C_L = 100pF$ (Figures 2, 7)	●	50	150	ns
	Differential Driver Rise/Fall Time with Single-Ended Load	$R_L = 3k, C_L = 100pF$ (Figures 3, 9)	●	50	150	ns
	Single-Ended Driver Rise/Fall Time	$R_L = 3k, C_L = 100pF$ (Figures 5, 10) (Note 5)	●	15	80	ns
$t_{HDIS}, t_{LDIS}$	Differential Driver Output Active to Disable	$C_L = 15pF$ (Figures 4, 8)	●	50	150	ns
	Any Receiver Output Active to Disable	$C_L = 15pF$ (Figures 4, 13)	●	30	100	ns
$t_{ENH}, t_{ENL}$	Differential Driver Enable to Output Active	$C_L = 15pF$ (Figures 4, 8)	●	50	150	ns
	Any Receiver, Enable to Output Active	$C_L = 15pF$ (Figures 4, 13)	●	30	100	ns
$V_{EER}$	Supply Rise Time From Shutdown or Receiver Keep-Alive	$C1 = C2 = 0.33\mu F, C_{VEE} = 1\mu F$	●	0.2		ms

The ● denotes specifications which apply over the full operating temperature range.

**Note 1:** Absolute maximum ratings are those values beyond which the life of a device may be impaired.

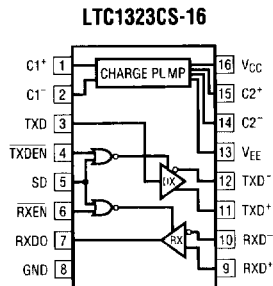
**Note 2:** All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to ground unless otherwise specified.

**Note 3:** All typicals are given at  $V_{CC} = 5V, T_A = 25^\circ C$ .

**Note 4:**  $I_{LOAD}$  is an external current being sunk into the  $V_{EE}$  pin.

**Note 5:** These specifications apply to the 24-pin package only.

## PIN FUNCTIONS

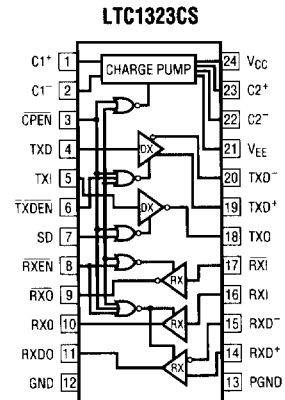


### (16-Pin/24-Pin)

**C1+ (Pin 1/Pin 1):** C1 Positive Input. Connect a  $0.33\mu F$  capacitor between  $C1+$  and  $C1-$ .

**C1- (Pin 2/Pin 2):** C1 Negative Input. Connect a  $0.33\mu F$  capacitor between  $C1+$  and  $C1-$ .

**CPEN (NA/Pin 3):** TTL Level Charge Pump Enable Input. With  $CPEN$  held low, the charge pump is enabled and the



chip operates normally. When  $CPEN$  is pulled high, the charge pump is disabled as well as both drivers, the noninverting single-ended receiver, and the differential receiver. The inverting single-ended receiver ( $R\bar{X}I$ ) is kept alive to monitor the control line and  $I_{CC}$  drops to  $65\mu A$ . To turn off the receiver and drop  $I_{CC}$  to  $0.5\mu A$ , pull the S/D pin high.

## PIN FUNCTIONS

**TXD (Pin 3/Pin 4):** Differential Driver Input (TTL compatible).

**TXI (NA/Pin 5):** Single-Ended Driver Input (TTL compatible).

**TXDEN (Pin 4/Pin 6):** Differential Driver Output Enable (TTL compatible). A high level on this pin forces the differential driver into three-state; a low level enables the driver. This input does not affect the single-ended driver.

**S/D (Pin 5/Pin 7):** Shutdown Input (TTL compatible). When this pin is high, the chip is shut down. All driver and receiver outputs are three-state, the charge pump turns off, and the supply current drops to 0.5 $\mu$ A. A low level on this pin allows normal operation.

**R $\overline$ XEN (Pin 6/Pin 8):** Receiver Enable (TTL compatible). A high level on this pin disables the receivers and three-states the logic outputs; a low level allows normal operation.

**R $\overline$ XO (NA/Pin 9):** Inverting Single-Ended Receiver Output. Remains active in the receiver keep-alive mode.

**R $\overline$ XO (NA/Pin 10):** Noninverting Single-Ended Receiver Output.

**R $\overline$ XDO (Pin 7/Pin 11):** Differential Receiver Output.

**GND (Pin 8/Pin 12):** Signal Ground. Connect to PGND with 24-pin package.

**PGND (NA/Pin 13):** Power ground is connected internally to the charge pump and differential driver. Connect to the GND pin.

**R $\overline$ XD $^+$  (Pin 9/Pin 14):** Differential Receiver Noninverting Input. When this pin is  $\geq 200$ mV above R $\overline$ XD $^-$ , R $\overline$ XDO will be high; when this pin is  $\geq 200$ mV below R $\overline$ XD $^-$ , R $\overline$ XDO will be low.

**R $\overline$ XD $^-$  (Pin 10/Pin 15):** Differential Receiver Inverting Input.

**R $\overline$ XI (NA/Pin 16):** Noninverting Receiver Input. This input controls the R $\overline$ XO output.

**R $\overline$ XI (NA/Pin 17):** Inverting Receiver Input. This input controls the R $\overline$ XO output. In receiver keep-alive mode (CPEN high, S/D low), this receiver can be used to monitor a wake-up control signal.

**TXO (NA/Pin 18):** Single-Ended Driver Output.

**TXD $^+$  (Pin 11/Pin 19):** Differential Driver Noninverting Output.

**TXD $^-$  (Pin 12/Pin 20):** Differential Driver Inverting Output.

**V $\overline$ EE (Pin 13/Pin 21):** The Negative Supply Charge Pump Output. Requires a 1 $\mu$ F bypass capacitor to ground. If an external load is connected to the V $\overline$ EE pin, the bypass capacitor value should be increased to 4.7 $\mu$ F.

**C $2^-$  (Pin 14/Pin 22):** C $2$  Negative Input. Connect a 0.33 $\mu$ F capacitor between C $2^+$  and C $2^-$ .

**C $2^+$  (Pin 15/Pin 23):** C $2$  Positive Input. Connect a 0.33 $\mu$ F capacitor between C $2^+$  and C $2^-$ .

**V $\overline$ CC (Pin 16/Pin 24):** The Positive Supply Input. 4.5V  $\leq$  V $\overline$ CC  $\leq$  5.5V. Requires a 1 $\mu$ F bypass capacitor to ground.

## TEST CIRCUITS

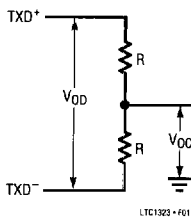


Figure 1

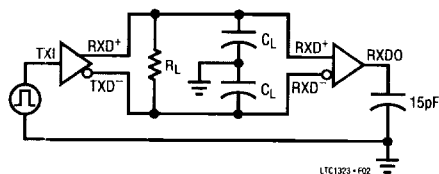


Figure 2

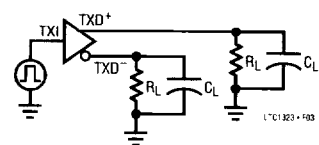


Figure 3

TEST CIRCUITS

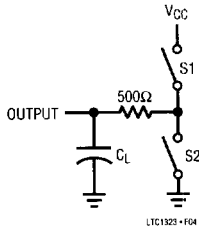


Figure 4

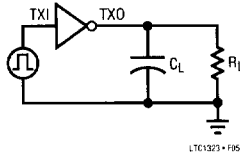


Figure 5

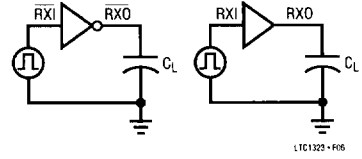


Figure 6

SWITCHING WAVEFORMS

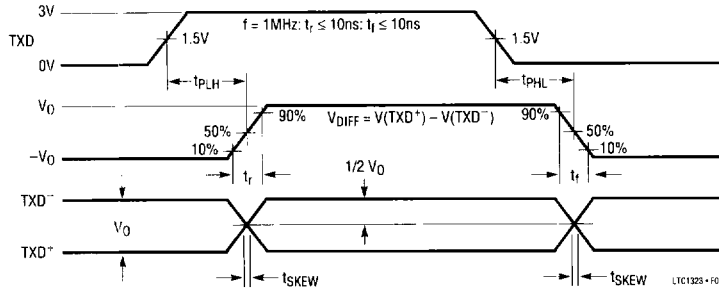


Figure 7. Differential Driver

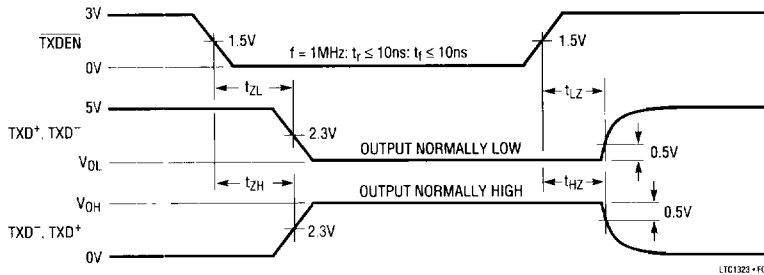


Figure 8. Differential Driver Enable and Disable

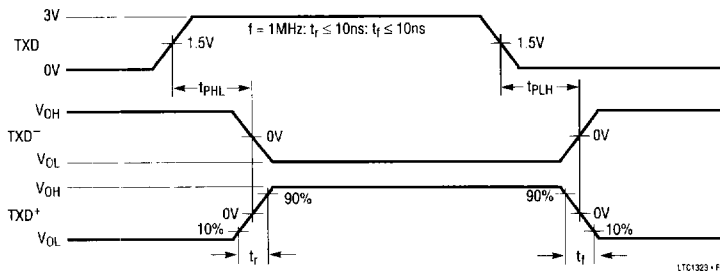


Figure 9. Differential Driver With Single-Ended Load

# SWITCHING WAVEFORMS

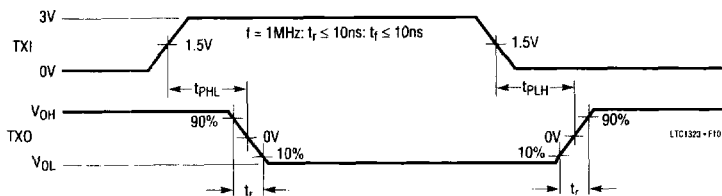


Figure 10. Single-Ended Driver

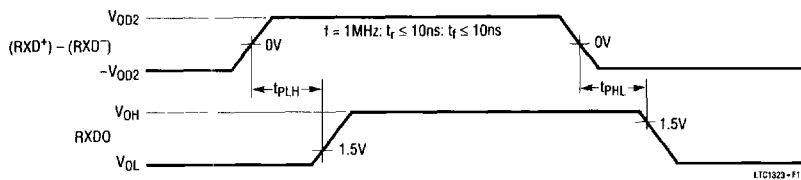


Figure 11. Differential Receiver

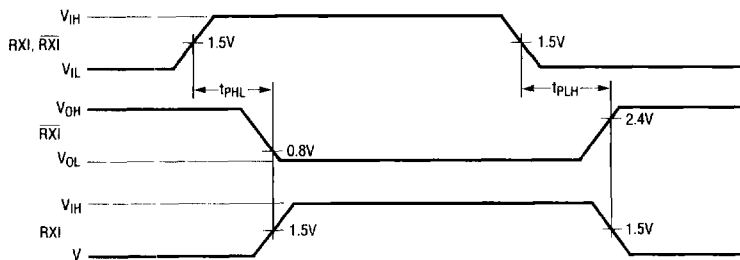


Figure 12. Single-Ended Receiver

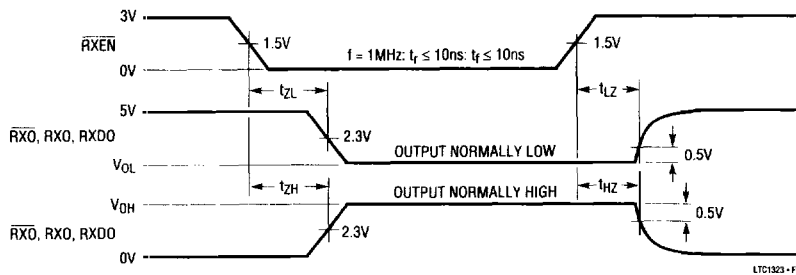


Figure 13. Receiver Enable and Disable

## APPLICATIONS INFORMATION

### Thermal Shutdown Protection

The LTC1323 includes a thermal shutdown circuit which protects against prolonged shorts at the driver outputs. If a driver output is shorted to another output or to the power supply, the current will be initially limited to a maximum of 250mA. When the die temperature rises above 150°C, the thermal shutdown circuit turns off the driver outputs. When the die cools to about 130°C, the outputs re-enable. If the short still exists, the part will heat again and the cycle will repeat. This oscillation occurs at about 10Hz and prevents the part from being damaged by excessive power dissipation. When the short is removed, the part will return to normal operation.

### Power Shutdown

The power shutdown feature of the LTC1323 is designed for battery-powered systems. When S/D is forced high the part enters shutdown mode. In shutdown the supply current typically drops from 2.4mA to 0.5 $\mu$ A, the charge pump turns off, and the driver and receiver outputs are three-stated.

### Supply Bypassing

The LTC1323 requires that both  $V_{CC}$  and  $V_{EE}$  are well bypassed to prevent data errors. A 1 $\mu$ F capacitor from  $V_{CC}$  to ground is adequate. A 1 $\mu$ F capacitor is required from  $V_{EE}$  to ground and should be increased to 4.7 $\mu$ F if an external load is connected to the  $V_{EE}$  pin.

### Driving an External Load from $V_{EE}$

An external load may be connected between ground and the  $V_{EE}$  pin as shown in Figure 14.

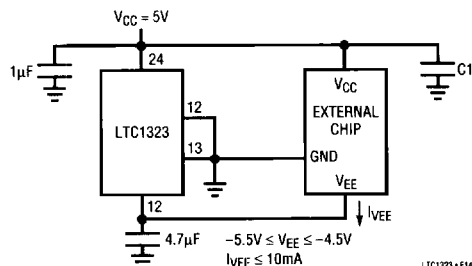


Figure 14

The LTC1323  $V_{EE}$  pin will sink up to a maximum of 10mA while maintaining the pin voltage between  $-4.5V$  and  $-5.5V$ . If an external load is connected, the  $V_{EE}$  bypass capacitor should be increased to 4.7 $\mu$ F. Both chips should have separate  $V_{CC}$  bypass capacitors but can share the  $V_{EE}$  capacitor.

### Driving AppleTalk or Single-Ended Loads

The differential driver is able to drive either an AppleTalk load or a single-ended load such as a printer. With a differential AppleTalk load,  $TXD^+$  and  $TXD^-$  will typically swing between 1.2V and 3.5V (Figure 15a). With a single-ended 3k load such as a printer,  $TXD^+$  or  $TXD^-$  will meet the EIA562 voltage swing requirement of  $\pm 3.7V$  (Figure 15b).

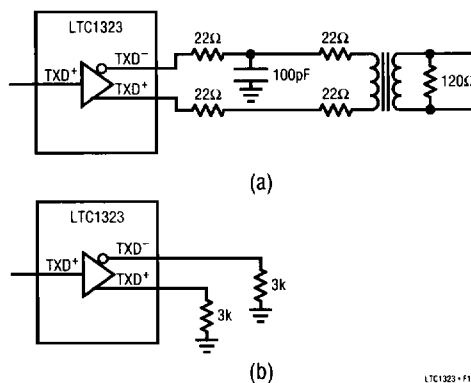


Figure 15

### Receiver Keep-Alive Mode (24-Pin Package Only)

When  $\overline{CPEN}$  is pulled high the charge pump is turned off and the outputs of both drivers, the noninverting single-ended receiver and the differential receiver are forced into three-state. The inverting single-ended receiver (RXI) is kept alive with  $I_{CC}$  dropping to 65 $\mu$ A and the receiver delay time increasing to a maximum of 400ns. The receiver can then be used to monitor a wake-up control signal.



## APPLICATIONS INFORMATION

### EMI Filter

Most LocalTalk applications use an electromagnetic interference (EMI) filter consisting of a resistor-capacitor T network between each driver and receiver and the connector. Unfortunately, the resistors significantly attenuate the driver's signal applied to the cable. Because the LTC1323 uses a single supply driver, the resistor values should be reduced to  $5\Omega$  to  $10\Omega$  to insure enough voltage swing on the cable (Figure 16). In most applications, removing the resistors completely does not cause an increase in EMI as long as a shielded connector and cable are used. With the resistors removed the only DC load becomes the primary

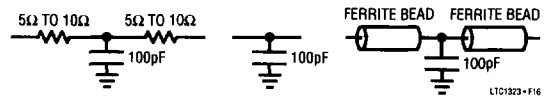


Figure 16. EMI Filters

of the LocalTalk transformer. This will increase the DC standby current when the drivers are active, but does not adversely affect the drivers because they can handle a direct short circuit indefinitely. For maximum swing and EMI immunity, a ferrite bead and capacitor could be used.